

| L Number | Hits  | Search Text   | DB  | Time stamp       |
|----------|-------|---|---|------------------|
| -        | 36415 | (thermal adj interface) or (phase adj change)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:34 |
| -        | 1     | ((thermal adj interface) or (phase adj change)) and (filler near fusible)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/07/18 18:25 |
| -        | 1     | (thermal adj interface) and (phase adj change adj polymer)  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/08/27 18:44 |
| -        | 93    | (phase adj change) near polymer   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/08/27 18:28 |
| -        | 2     | ((phase adj change) near polymer) and (thermal adj interface)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/08/27 18:28 |
| -        | 55    | (thermal adj interface) and (phase adj change) and filler   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/08/27 18:45 |
| -        | 2     | (thermal adj interface) and (phase adj change) and (fusible near filler)  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:13 |
| -        | 44    | (thermal adj interface adj material) and (phase adj change) and filler  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/08/27 18:47 |
| -        | 20    | (lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:14 |
| -        | 37657 | (thermal adj interface) or (phase adj change)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:14 |
| -        | 2     | ((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and ((thermal adj interface) or (phase adj change)) | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:18 |
| -        | 6     | ((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and phase   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:19 |

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| - | 20    | (lead or cadmium or mercury, antimony or arsenic) and (fusible near filler)                  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/01 16:28 |
| - | 37735 | (thermal adj interface) or (phase adj change)  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:34 |
| - | 315   | Jayaraman.IN.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:35 |
| - | 2306  | Konig.IN.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:35 |
| - | 237   | Dani.IN.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:35 |
| - | 2852  | Jayaraman.IN. or Konig.IN. or Dani.IN.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:35 |
| - | 10    | (Jayaraman.IN. or Konig.IN. or Dani.IN.) and ((thermal adj interface) or (phase adj change)) | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 11:41 |
| - | 3304  | (428/323).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:37 |
| - | 583   | (428/673).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:37 |
| - | 2201  | (428/402).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:37 |
| - | 296   | (428/645).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:37 |
| - | 1220  | (524/432).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:38 |
| - | 1519  | (524/495).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:38 |

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|---|------|--|---|------------------|
| - | 1224 | (524/437).CCLS.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:38 |
| - | 9951 | ((428/323).CCLS.) or ((428/673).CCLS.) or<br>((428/402).CCLS.) or ((428/645).CCLS.) or<br>((524/432).CCLS.) or ((524/495).CCLS.) or<br>((524/437).CCLS.)   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 10:39 |
| - | 87   | ((428/323).CCLS.) or ((428/673).CCLS.) or<br>((428/402).CCLS.) or ((428/645).CCLS.) or<br>((524/432).CCLS.) or ((524/495).CCLS.) or<br>((524/437).CCLS.)) and ((thermal adj interface) or (phase adj<br>change))                         | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 11:41 |
| - | 23   | ((428/323).CCLS.) or ((428/673).CCLS.) or<br>((428/402).CCLS.) or ((428/645).CCLS.) or<br>((524/432).CCLS.) or ((524/495).CCLS.) or<br>((524/437).CCLS.)) and ((thermal adj interface) or (phase adj<br>change)) and (fusible or melted) | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/10/02 11:42 |